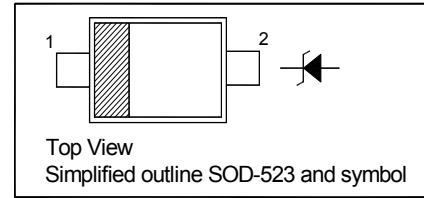


# ESD5P5V0

## ESD Protection Diode

### PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



### Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Value	Unit
Peak Power ( $t_p = 8/20 \mu\text{s}$ )	$P_{PK}$	107	W
Peak Pulse Current ( $t_p = 8/20 \mu\text{s}$ )	$I_{PP}$	8.7	A
IEC61000-4-2 (ESD) Air Contact	$V_{ESD}$	$\pm 30$	KV
Power Dissipation <sup>1)</sup>	$P_D$	150	mW
Junction Temperature Range	$T_j$	- 55 to + 150	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	- 55 to + 150	$^\circ\text{C}$

### Thermal Characteristics

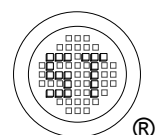
Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient <sup>1)</sup>	$R_{\theta JA}$	833	$^\circ\text{C/W}$

<sup>1)</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

### Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Min.	Typ.	Max.	Unit
Reverse Stand-Off Voltage	$V_{RWM}$	-	-	5	V
Reverse Breakdown Voltage at $I_R = 1 \text{ mA}$	$V_{(BR)R}$	6.2	-	-	V
Reverse Current at $V_{RWM} = 5 \text{ V}$	$I_R$	-	-	1	$\mu\text{A}$
Forward Voltage at $I_F = 10 \text{ mA}$	$V_F$	-	-	0.9	V
Clamping Voltage at $I_{PP} = 8.7 \text{ A}$ , $t_p = 8/20 \mu\text{s}$	$V_C$	-	-	12.3	V
ESD Clamping Voltage at $I_{TLP} = 4 \text{ A}$ , $t_p = 0.2/100 \text{ ns}$ at $I_{TLP} = 16 \text{ A}$ , $t_p = 0.2/100 \text{ ns}$	$V_{CL}$	-	9.1 13.4	-	V
Junction Capacitance at $V_R = 0 \text{ V}$ , $f = 1 \text{ MHz}$	$C_j$	-	65	-	pF
Dynamic Resistance <sup>1)</sup>	$R_{dyn}$	-	0.36	-	$\Omega$

<sup>1)</sup> Dynamic Resistance calculated from  $I_{TLP} = 4 \text{ A}$  to  $I_{TLP} = 16 \text{ A}$ .



# ESD5P5V0

## Electrical Characteristics Curves

Fig 1. Pulse Waveform

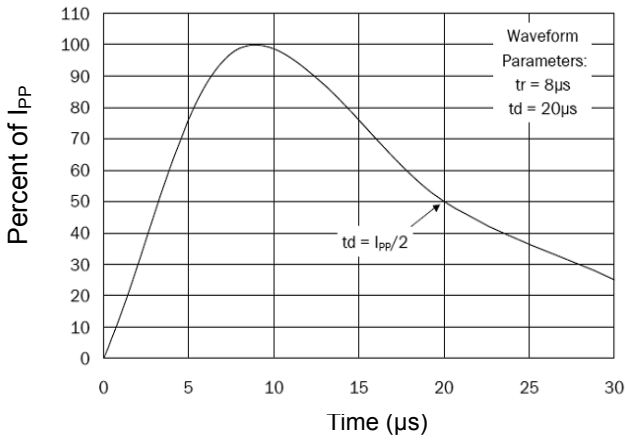


Fig 2. Power Derating Curve

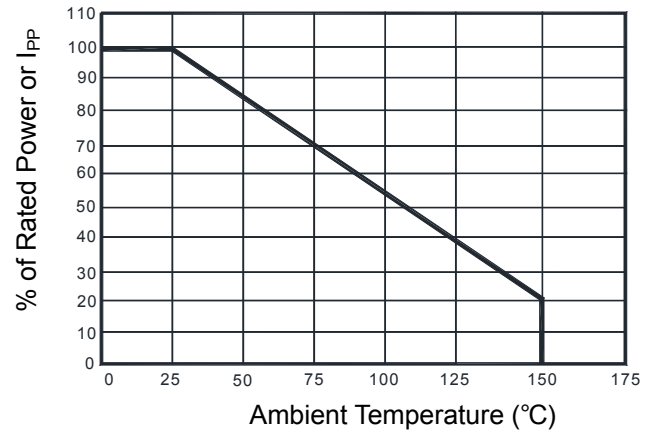


Fig 3. Clamping Voltage Curve

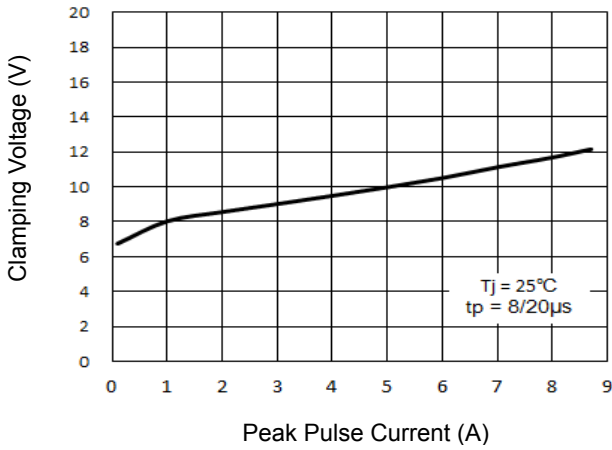


Fig 4. Junction Capacitance

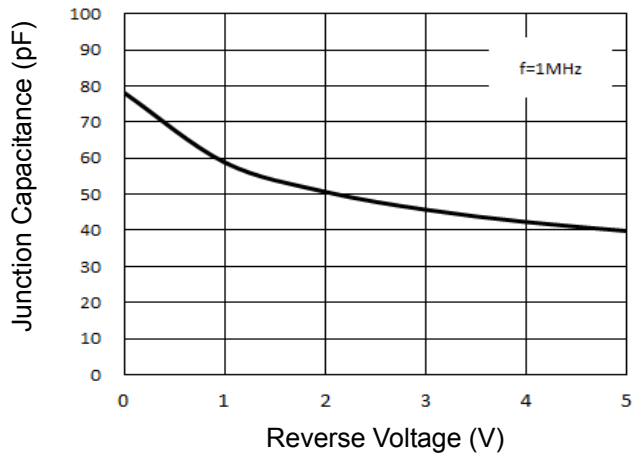
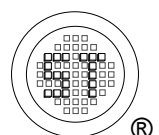
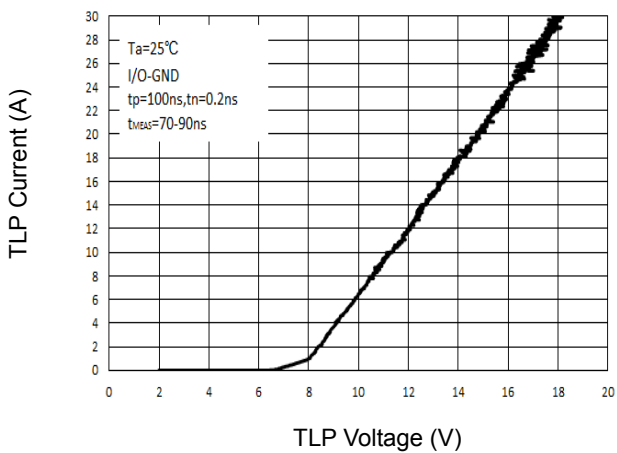


Fig 5 TLP Curve

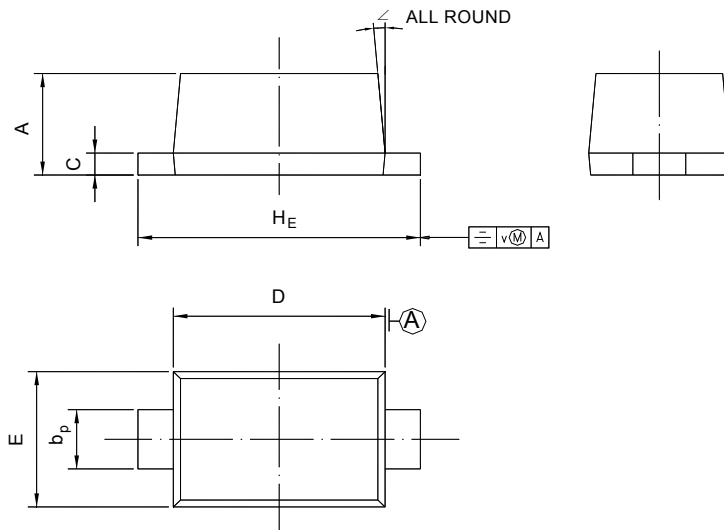


# ESD5P5V0

## PACKAGE OUTLINE

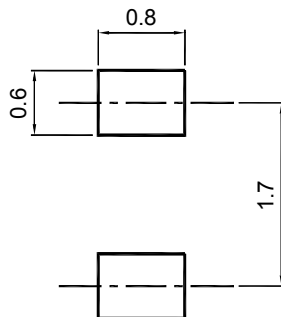
Plastic surface mounted package; 2 leads

SOD-523



UNIT	A	b <sub>p</sub>	C	D	E	H <sub>E</sub>	V	∠
mm	0.70 0.60	0.4 0.3	0.135 0.100	1.25 1.15	0.85 0.75	1.7 1.5	0.1	5°

### Recommended Soldering Footprint



### Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOD-523	8	4 ± 0.1	0.157 ± 0.004	178	7	4,000

### Marking information

" XB " = Part No.

" III " = Cathode line

Font type: Arial

